## SN74ALVC16409 9-BIT, 4-PORT UNIVERSAL BUS EXCHANGER WITH 3-STATE OUTPUTS

SCAS259 - NOVEMBER 1993 - REVISED MARCH 1994

### Member of the Texas Instruments DGG OR DL PACKAGE (TOP VIEW) Widebus+™ Family EPIC<sup>™</sup> (Enhanced-Performance Implanted PRE 56 🛛 CLK **CMOS) Submicron Process** 55 SELEN SEL0 2 UBE™ (Universal Bus Exchanger) Allows 1A1 📙 3 54**∏** 1B1 Synchronous Data Exchange GND 4 53 GND Designed to Facilitate Incident-Wave 1A2 5 52**∏** 1B2 Switching for Line Impedances of 50 $\Omega$ 51 1B3 1A3 🛮 6 or Greater 50 [] V<sub>CC</sub> Vcc L Typical V<sub>OLP</sub> (Output Ground Bounce) 1A4 🛮 8 49**∏** 1B4 < 0.8 V at $V_{CC}$ = 3.3 V, $T_A$ = 25°C 1A5 📙 9 48**∏** 1B5 47 🛛 1B6 1A6 🛮 10 Typical V<sub>OHV</sub> (Output V<sub>OH</sub> Undershoot) 46∏ GND > 2 V at V<sub>CC</sub> = 3.3 V, T<sub>A</sub> = 25°C GND I 11 1A7 | 12 45**∏** 1B7 ESD Protection Exceeds 2000 V Per 1A8 🛮 13 44**∏** 1B8 MIL-STD-883C. Method 3015: Exceeds 43**∏** 1B9 1A9 14 200 V Using Machine Model (C = 200 pF, 42 **□** 2B1 2A1 | 15 2A2 **∏** 16 41 **∏** 2B2 Bus-Hold On Data Inputs Eliminates the 2A3 17 40**∏** 2B3 **Need for External Pullup/Pulldown** GND 18 39 **∏** GND Resistors 2A4 **∏** 19 38**∏** 2B4 Latch-Up Performance Exceeds 250 mA 2A5 ∏ 20 37 1 2B5 Per JEDEC Standard JESD-17 36**∏** 2B6 2A6 | 21 Package Options Include Plastic 300-mil 35 V<sub>CC</sub> V<sub>CC</sub> 1 22 Shrink Small-Outline (DL) and Thin Shrink 2A7 23 34 2B7 Small-Outline (DGG) Packages 2A8 | 24 33**∏** 2B8 GND II 25 32 **∏** GND description 2A9 **∏** 26 31 **∏** 2B9 SEL1 27 30 SEL4 The SN74ALVC16409 allows synchronous data SEL2 29 ¶ SEL3

Data flow is controlled by the select (SEL0-SEL4) inputs. A data-flow state is stored on the rising edge of the clock (CLK) input, provided the select-enable (SELEN) input is low. Once a data-flow state has been established, data is stored in the flip-flop on the rising edge of the CLK, provided SELEN is high.

The data-flow control logic is designed to allow glitch-free data transmission.

Active bus-hold circuitry is provided to hold unused or floating data inputs at a valid logic level.

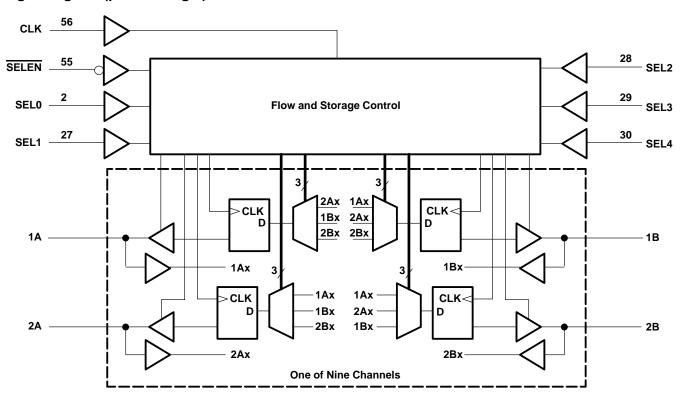
The SN74ALVC16409 is available in Ti's shrink small-outline (DL) and thin shrink small-outline (DGG) packages, which provide twice the I/O pin count and functionality of standard small-outline packages in the same printed-circuit-board area.

The SN74ALVC16409 is characterized for operation from -40°C to 85°C.

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exchange between four different buses.





## **FUNCTION TABLE**

| INF      | PUTS         | OUTPUT           |
|----------|--------------|------------------|
| CLK      | SEND<br>PORT | RECEIVE<br>PORT  |
| Х        | Х            | в <sub>0</sub> † |
| Х        | L            | L                |
| Х        | Н            | Н                |
| <b>↑</b> | L            | L                |
| <b>↑</b> | Н            | Н                |
| Н        | Х            | в <sub>0</sub> † |
| L        | Х            | в <sub>0</sub> † |

<sup>†</sup>Output level before the indicated steady-state input conditions were established.

# **SN74ALVC16409** 9-BIT, 4-PORT UNIVERSAL BUS EXCHANGER WITH 3-STATE OUTPUTS SCAS259 - NOVEMBER 1993 - REVISED MARCH 1994

## **DATA-FLOW CONTROL FUNCTION TABLE**

| INPUTS |            |      |      |      |      |      |                       |
|--------|------------|------|------|------|------|------|-----------------------|
| SELEN  | CLK        | SEL0 | SEL1 | SEL2 | SEL3 | SEL4 | DATA FLOW             |
| Н      | 1          | Х    | Х    | Χ    | Χ    | Χ    | No change             |
| L      | $\uparrow$ | 0    | 0    | 0    | 0    | 0    | None, all I/Os off    |
| L      | $\uparrow$ | 0    | 0    | 0    | 0    | 1    | Not used              |
| L      | $\uparrow$ | 0    | 0    | 0    | 1    | 0    | Not used              |
| L      | $\uparrow$ | 0    | 0    | 0    | 1    | 1    | Not used              |
| L      | $\uparrow$ | 0    | 0    | 1    | 0    | 0    | Not used              |
| L      | $\uparrow$ | 0    | 0    | 1    | 0    | 1    | Not used              |
| L      | $\uparrow$ | 0    | 0    | 1    | 1    | 0    | Not used              |
| L      | $\uparrow$ | 0    | 0    | 1    | 1    | 1    | Not used              |
| L      | $\uparrow$ | 0    | 1    | 0    | 0    | 0    | 2A to 1A and 1B to 2B |
| L      | $\uparrow$ | 0    | 1    | 0    | 0    | 1    | 2A to 1A              |
| L      | $\uparrow$ | 0    | 1    | 0    | 1    | 0    | 2B to 1B              |
| L      | $\uparrow$ | 0    | 1    | 0    | 1    | 1    | 2A to 1A and 2B to 1B |
| L      | $\uparrow$ | 0    | 1    | 1    | 0    | 0    | 1A to 2A and 1B to 2B |
| L      | $\uparrow$ | 0    | 1    | 1    | 0    | 1    | 1A to 2A              |
| L      | $\uparrow$ | 0    | 1    | 1    | 1    | 0    | 1B to 2B              |
| L      | $\uparrow$ | 0    | 1    | 1    | 1    | 1    | 1A to 2A and 2B to 1B |
| L      | $\uparrow$ | 1    | 0    | 0    | 0    | 0    | 1A to 1B and 2B to 2A |
| L      | $\uparrow$ | 1    | 0    | 0    | 0    | 1    | 1A to 1B              |
| L      | $\uparrow$ | 1    | 0    | 0    | 1    | 0    | 2A to 2B              |
| L      | $\uparrow$ | 1    | 0    | 0    | 1    | 1    | 1A to 1B and 2A to 2B |
| L      | $\uparrow$ | 1    | 0    | 1    | 0    | 0    | 1B to 1A and 2A to 2B |
| L      | $\uparrow$ | 1    | 0    | 1    | 0    | 1    | 1B to 1A              |
| L      | $\uparrow$ | 1    | 0    | 1    | 1    | 0    | 2B to 2A              |
| L      | $\uparrow$ | 1    | 0    | 1    | 1    | 1    | 1B to 1A and 2B to 2A |
| L      | $\uparrow$ | 1    | 1    | 0    | 0    | 0    | 2B to 1A and 2A to 1B |
| L      | $\uparrow$ | 1    | 1    | 0    | 0    | 1    | 1B to 2A              |
| L      | $\uparrow$ | 1    | 1    | 0    | 1    | 0    | 2B to 1A              |
| L      | $\uparrow$ | 1    | 1    | 0    | 1    | 1    | 2B to 1A and 1B to 2A |
| L      | $\uparrow$ | 1    | 1    | 1    | 0    | 0    | 1A to 2B and 1B to 2A |
| L      | $\uparrow$ | 1    | 1    | 1    | 0    | 1    | 1A to 2B              |
| L      | $\uparrow$ | 1    | 1    | 1    | 1    | 0    | 2A to 1B              |
| L      | $\uparrow$ | 1    | 1    | 1    | 1    | 1    | 1A to 2B and 2A to 1B |



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## absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

| Supply voltage range, V <sub>CC</sub>   | 0.5 V to 4.6 V                             |
|---|--|
| Input voltage range, V <sub>I</sub> (except I/O ports) (see Note 1)                             | 0.5 V to 4.6 V                             |
| Input voltage range, V <sub>I</sub> (I/O ports) (see Notes 1 and 2)                             | $-0.5 \text{ V to V}_{CC} + 0.5 \text{ V}$ |
| Output voltage range, V <sub>O</sub> (see Notes 1 and 2)  | $-0.5 \text{ V to V}_{CC} + 0.5 \text{ V}$ |
| Input clamp current, $I_{IK}$ ( $V_I < 0$ )   | –50 mA                                     |
| Output clamp current, I <sub>OK</sub> (V <sub>O</sub> < 0 or V <sub>O</sub> > V <sub>CC</sub> ) | ±50 mA                                     |
| Continuous output current, $I_O$ ( $V_O = 0$ to $V_{CC}$ )                                      | ±50 mA                                     |
| Continuous current through V <sub>CC</sub> or GND pins  | ±100 mA                                    |
| Maximum power dissipation at $T_A = 55^{\circ}C$ (in still air): DGG package                    | 1 W  |
| DL package .  | 1.4 W                                      |
| Storage temperature range   | –65°C to 150°C                             |

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

## recommended operating conditions

|                 |                                    |  | MIN | MAX  | UNIT |
|-----------------|------------------------------------|--|-----|------|------|
| VCC             | Supply voltage                     |  | 2.7 | 3.6  | V    |
| ٧ <sub>IH</sub> | High-level input voltage           | $V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$ | 2   |      | V    |
| $V_{IL}$        | Low-level input voltage            | $V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$ |     | 0.8  | V    |
| VI              | Input voltage                      |  | 0   | VCC  | V    |
| VO              | Output voltage                     |  | 0   | VCC  | V    |
| la              | High level output ourrant          | $V_{CC} = 2.7 \text{ V}$                   |     | -12  | mA   |
| ЮН              | High-level output current          | V <sub>CC</sub> = 3 V                      |     | -24‡ | IIIA |
| 1               | Low-level output current           | V <sub>CC</sub> = 2.7 V                    |     | 12   | mA   |
| lOL             | V <sub>CC</sub> = 3 V              |  |     | 24‡  | IIIA |
| Δt/Δν           | Input transition rise or fall rate |  | 0   | 10   | ns/V |
| T <sub>A</sub>  | Operating free-air temperature     |  | -40 | 85   | °C   |

<sup>‡</sup> Current duty cycle  $\leq$  50%, f  $\geq$  1 kHz



NOTES: 1. The input and output voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

<sup>2.</sup> This value is limited to 4.6 V maximum.

# RODUCT PREVIEW

# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER         |                | TEST CONDITIONS   | v <sub>cc</sub> † | MIN                 | TYP | MAX  | UNIT |  |  |
|-------------------|----------------|---|-------------------|---------------------|-----|------|------|--|--|
| VIK               |                | I <sub>I</sub> = -18 mA   | 2.7 V             |                     |     | -1.2 | V    |  |  |
|                   |                | I <sub>OH</sub> = -100 μA   | MIN to MAX        | V <sub>CC</sub> -0. | 2   |      |      |  |  |
| \/                |                | 10 10.m4  | 2.7 V             | 2.2                 |     |      | V    |  |  |
| VOH               |                | IOH = -12 mA  | 3 V               | 2.4                 |     |      |      |  |  |
|                   |                | $I_{OH} = -24 \text{ mA}$   | 3 V               | 2                   |     |      |      |  |  |
|                   |                | I <sub>OL</sub> = 100 μA  | MIN to MAX        |                     |     | 0.2  |      |  |  |
| VOL               |                | I <sub>OL</sub> = 12 mA   | 2.7 V             |                     |     | 0.4  | V    |  |  |
|                   |                | I <sub>OL</sub> = 24 mA   | 3 V               |                     |     | 0.55 |      |  |  |
| II                |                | $V_I = V_{CC}$ or GND   | 3.6 V             |                     |     | ±5   | μΑ   |  |  |
| 1.0 . 0           | Data pins      | V <sub>I</sub> = 0.8 V  | 3 V               | 75<br>-75           |     |      | ^    |  |  |
| l(hold)           |                | V <sub>I</sub> = 2 V  | ] <sup>3</sup> V  |                     |     |      | μΑ   |  |  |
| l <sub>OZ</sub> ‡ |                | $V_O = V_{CC}$ or GND   | 3.6 V             |                     |     | ±10  | μΑ   |  |  |
| Icc               |                | $V_I = V_{CC}$ or GND, $I_O = 0$  | 3.6 V             |                     |     | 40   | μΑ   |  |  |
| ΔICC              |                | $V_{CC}$ = 3 V to 3.6 V, One input at $V_{CC}$ – 0.6 V, Other inputs at $V_{CC}$ or GND |                   |                     |     | 750  | μΑ   |  |  |
| Ci                | Control inputs | V <sub>I</sub> = V <sub>CC</sub> or GND   | 3.3 V             |                     |     |      | pF   |  |  |
| C <sub>io</sub>   | A or B ports   | $V_O = V_{CC}$ or GND   | 3.3 V             |                     |     |      | pF   |  |  |

<sup>†</sup> For conditions shown as MIN or MAX, use the appropriate values under recommended operating conditions.

# timing requirements over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

|                 |                 |                    |     | V <sub>CC</sub> = 3.3 V<br>± 0.15 V |     | 3.3 V<br>3 V | V <sub>CC</sub> = 2.7 V | UNIT |
|-----------------|-----------------|--------------------|-----|-------------------------------------|-----|--------------|-------------------------|------|
|                 |                 |                    | MIN | MAX                                 | MIN | MAX          | MIN                     |      |
| fclock          | Clock frequency |                    | 0   | 75                                  |     |              |                         | MHz  |
| t <sub>W</sub>  | Pulse duration  | CLK high or low    |     |                                     |     |              |                         | ns   |
|                 |                 | A or B before CLK↑ |     | 0.8                                 |     |              |                         |      |
| t <sub>su</sub> | Setup time      | S before CLK↑      |     | 5                                   |     |              |                         | ns   |
|                 |                 | SELEN before CLK↑  |     |                                     |     |              |                         |      |
|                 |                 | A or B after CLK↑  |     | 2                                   |     |              |                         |      |
| <sup>t</sup> h  | Hold time       | S after CLK↑       |     | 0.5                                 |     |              |                         | ns   |
|                 |                 | SELEN after CLK↑   |     |                                     |     |              |                         |      |

# switching characteristics over recommended ranges of supply voltage and operating free-air temperature, $C_L = 50$ pF (unless otherwise noted) (see Note 3)

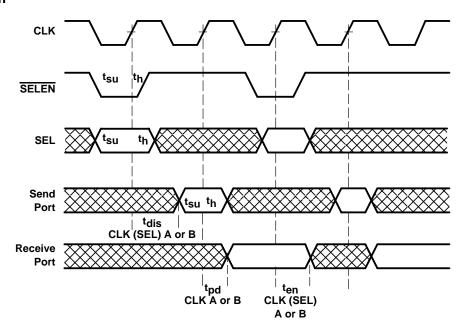
| PARAMETER        | FROM         | TO (OUTPUT) | V <sub>CC</sub> = 3.3 V<br>± 0.15 V |     | V <sub>CC</sub> = 3.3 V<br>± 0.3 V |     |     | V <sub>CC</sub> = 2.7 V | UNIT |     |
|------------------|--------------|-------------|-------------------------------------|-----|------------------------------------|-----|-----|-------------------------|------|-----|
|                  | (INPUT)      | (OUTPUT)    | MIN                                 | TYP | MAX                                | MIN | TYP | MAX                     | MAX  |     |
| fmax             |              |             | 75                                  |     |                                    |     |     |                         |      | MHz |
| <sup>t</sup> pd  | CLK (A or B) | B or A      |                                     |     | 4                                  |     |     |                         |      | ns  |
| t <sub>en</sub>  | CLK (SEL)    | B or A      |                                     |     |                                    |     |     |                         |      | ns  |
| <sup>t</sup> dis | CLK (SEL)    | B or A      |                                     |     |                                    |     |     |                         |      | ns  |

NOTE 3: Load circuit and voltage waveforms are shown in Section 1.



<sup>‡</sup> For I/O ports, the parameter IOZ includes the input leakage current.

## timing diagram





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